KSW160N10S

100V N-Channel MOSFET

GeneralDescription

The KSW160N10S uses advanced MOSFET technology to provide excellent R_{DS}(ON), low gate charge fast switching and excellent avalanche characteristics. This device is specially designed to get better ruggedness and suitable to use in

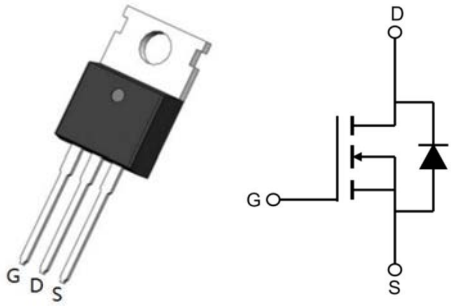
Product Summary

V_{DS} (V)	R_{DS}(on) (mΩ)	I_D (A)
100	4.0 at V_{GS} = 10 V	160

Features

- Extremely low switching loss
- Green Device Available
- *Excellent stability and uniformity or Invertors*

TO-220 Pin Configuration



Applications

- Motor control
- PWM applications
- Uninterruptible power supply
- Synchronous-rectification

100% UIS TESTED!
100% ΔVds TESTED!

Absolute Maximum Ratings Tc=25℃ unless otherwise noted

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	±20	V
I_D	Drain Current – Continuous (T_C=25℃)	160	A
	Drain Current – Continuous (T_C=100℃)	80	A
I_{DM}	Drain Current – Pulsed[1]	430	A
P_D	Power Dissipation (T_C=25℃)	160	W
	Power Dissipation – Derate above 25℃	1.5	W/℃
T_{STG}	Storage Temperature Range	-55 to 150	℃
T_J	Operating Junction Temperature Range	-55 to 150	℃

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	53	℃/W
$R_{\theta JC}$	Thermal Resistance Junction to Case	---	1.2	℃/W

Electrical Characteristics (T_J=25 ℃, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V , I_D=250uA	100	---	---	V
$\triangle BV_{DSS}/\triangle T_J$	BV_{DSS} Temperature Coefficient	Reference to 25℃ , I_D=1mA	---	0.01	---	V/℃
I_{DSS}	Drain-Source Leakage Current	V_{DS}=80V , V_{GS}=0V , T_J=25℃	---	---	1	uA
		V_{DS}=80V , V_{GS}=0V , T_J=125℃	---	---	10	uA
I_{GSS}	Gate-Source Leakage Current	V_{GS}=±20V , V_{DS}=0V	---	---	±100	nA

On Characteristics

$R_{DS(ON)}$	Static Drain-Source On-Resistance	V_{GS}=10V , I_D=15A	---	4.0	5.2	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS}=V_{DS} , I_D =250uA	1.8	2.5	3.6	V
$\triangle V_{GS(th)}$	$V_{GS(th)}$ Temperature Coefficient		---	1.6	---	mV/℃
gfs	Forward Transconductance	V_{DS}=10V , I_S=15A	---	40	---	S

Dynamic and switching Characteristics

Q_g	Total Gate Charge[2,3]	V_{DS}=50V , V_{GS}=10V , I_D=10A	---	67	---	nC
Q_{gs}	Gate-Source Charge[2,3]		---	16	---	
Q_{gd}	Gate-Drain Charge[2,3]		---	10	---	
$T_{d(on)}$	Turn-On Delay Time[2,3]	V_{DS}=50V , V_{GS}=10V , R_G=3.3 Ω I_D=10A	---	24	---	ns
T_r	Rise Time[2,3]		---	8	---	
$T_{d(off)}$	Turn-Off Delay Time[2,3]		---	46	---	
T_f	Fall Time[2,3]		---	7.5	---	
C_{iss}	Input Capacitance	V_{DS}=50V , V_{GS}=0V , F=1MHz	---	5930	---	pF
C_{oss}	Output Capacitance		---	690	---	
C_{rss}	Reverse Transfer Capacitance		---	17	---	

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current	V_G=V_D=0V , Force Current	---	---	120	A
I_{SM}	Pulsed Source Current		---	---	240	A
V_{SD}	Diode Forward Voltage	V_{GS}=0V , I_S=1A , T_J=25℃	---	---	1.2	V

Note :
1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width ≦ 300us , duty cycle ≦ 2%.
3. Essentially independent of operating temperature.

Typical Performance Characteristics（(TJ = 25 ℃, unless otherwise noted)）

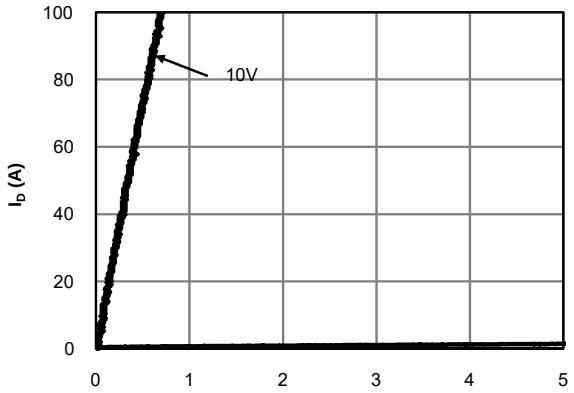


Fig 1: On-Region Characteristics

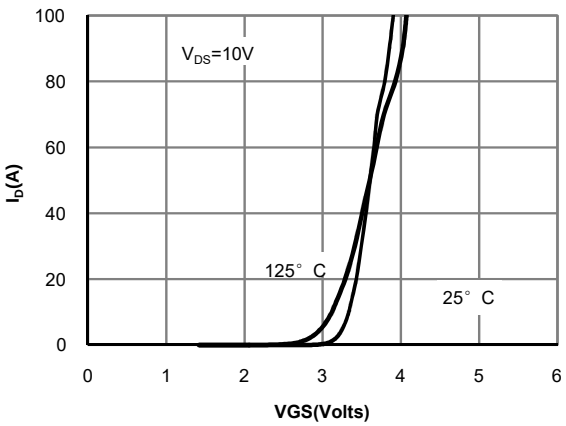


Figure 2: Transfer Characteristics

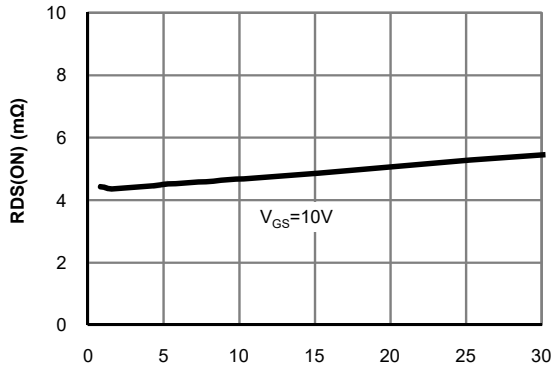


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

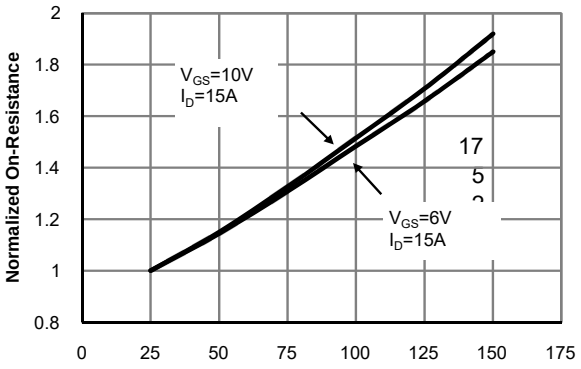


Figure 4: On-Resistance vs. Junction Temperature

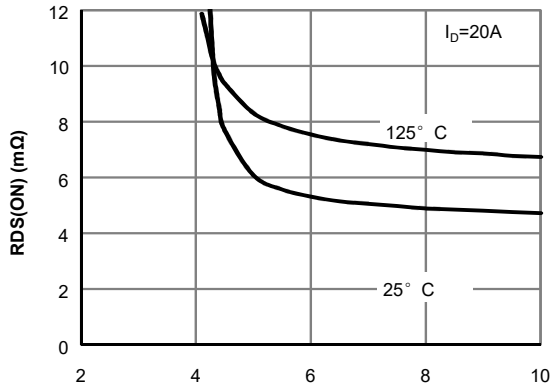


Figure 5: On-Resistance vs. Gate-Source Voltage

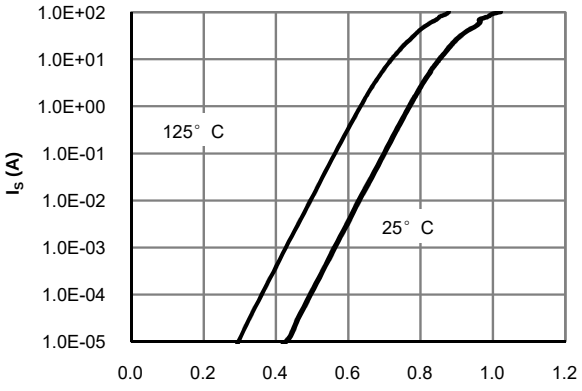


Figure 6: Body-Diode Characteristics

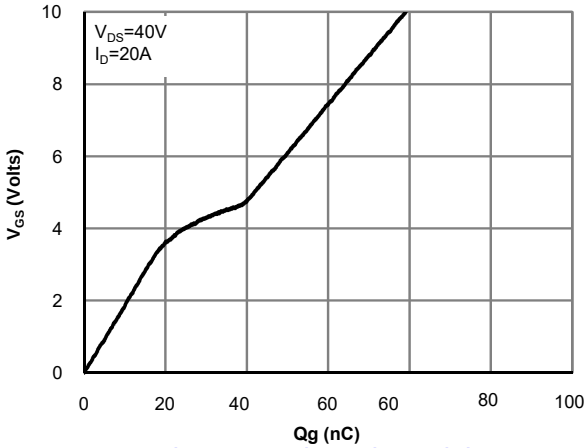


Figure 7: Gate-Charge Characteristics

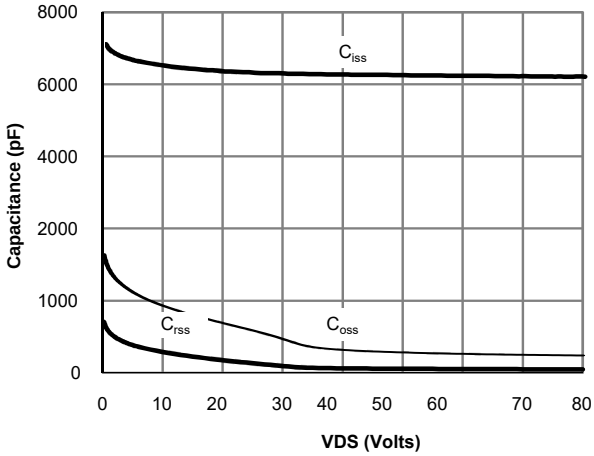


Figure 8: Capacitance Characteristics

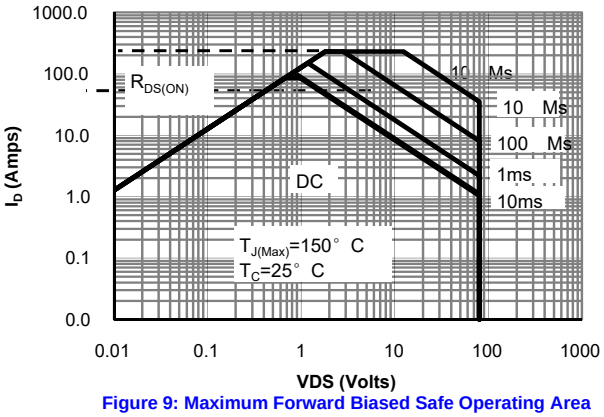


Figure 9: Maximum Forward Biased Safe Operating Area

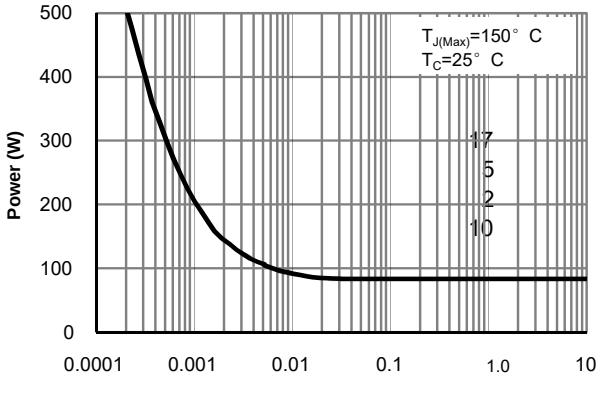


Figure 10: Single Pulse Power Rating Junction-to-Case

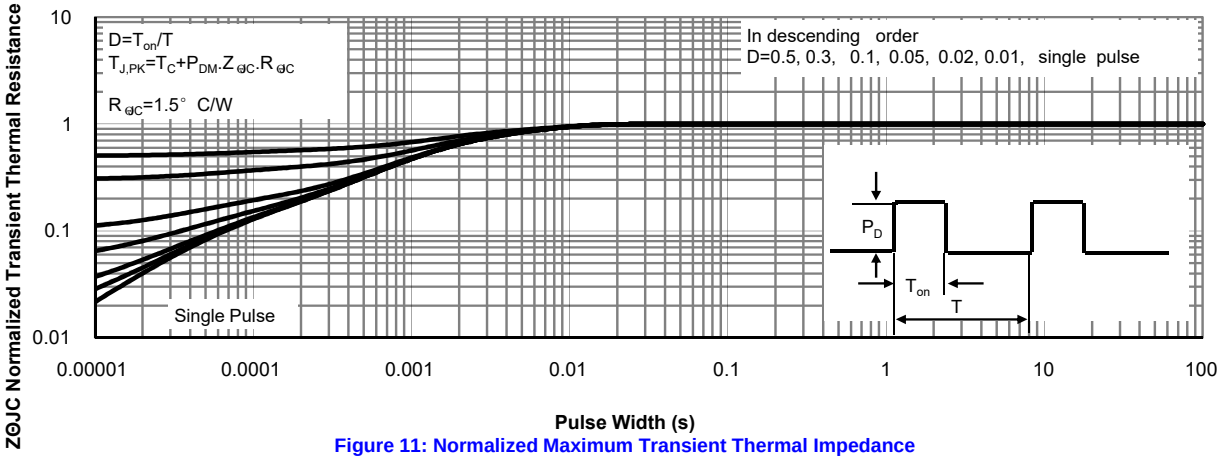


Figure 11: Normalized Maximum Transient Thermal Impedance

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